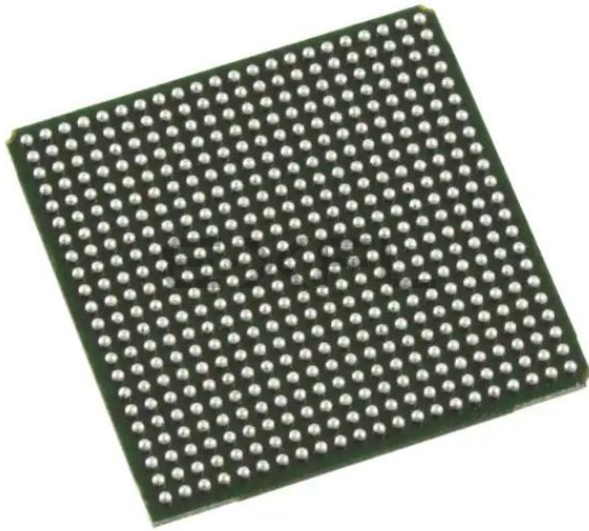




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	4000
Number of Logic Elements/Cells	32000
Total RAM Bits	339968
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-35se-5f484c

If an EBR is pre-loaded during configuration, the GSR input must be disabled or the release of the GSR during device Wake Up must occur before the release of the device I/Os becomes active.

These instructions apply to all EBR RAM and ROM implementations.

Note that there are no reset restrictions if the EBR synchronous reset is used and the EBR GSR input is disabled.

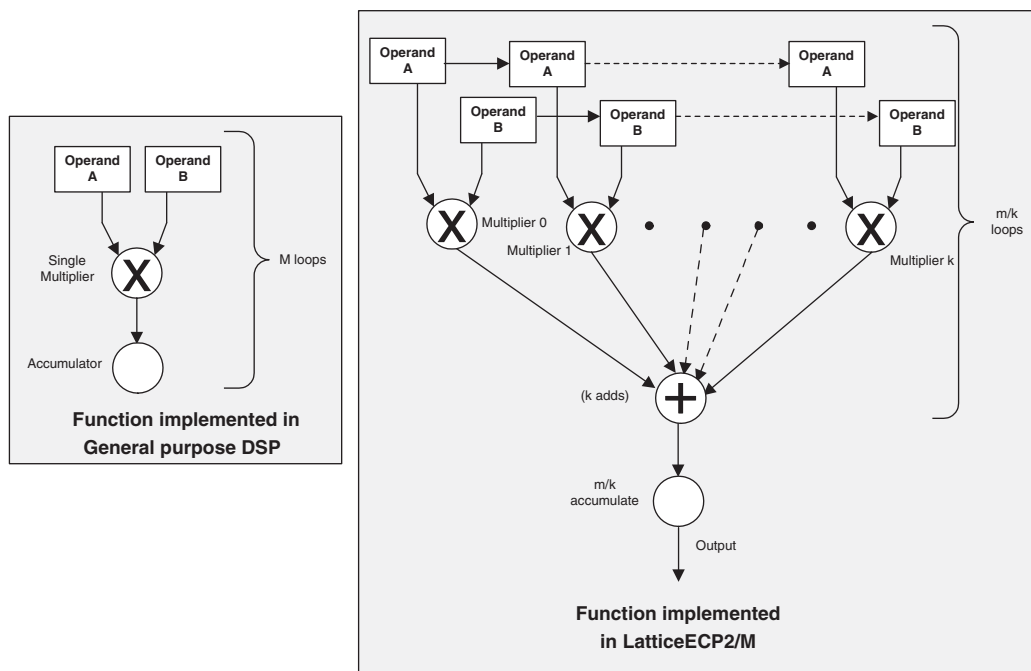
sysDSP™ Block

The LatticeECP2/M family provides a sysDSP block, making it ideally suited for low cost, high performance Digital Signal Processing (DSP) applications. Typical functions used in these applications are Finite Impulse Response (FIR) filters, Fast Fourier Transforms (FFT) functions, Correlators, Reed-Solomon/Turbo/Convolution encoders and decoders. These complex signal processing functions use similar building blocks such as multiply-adders and multiply-accumulators.

sysDSP Block Approach Compared to General DSP

Conventional general-purpose DSP chips typically contain one to four (Multiply and Accumulate) MAC units with fixed data-width multipliers; this leads to limited parallelism and limited throughput. Their throughput is increased by higher clock speeds. The LatticeECP2/M, on the other hand, has many DSP blocks that support different data-widths. This allows the designer to use highly parallel implementations of DSP functions. The designer can optimize the DSP performance vs. area by choosing an appropriate level of parallelism. Figure 2-22 compares the fully serial and the mixed parallel and serial implementations.

Figure 2-22. Comparison of General DSP and LatticeECP2/M Approaches



sysDSP Block Capabilities

The sysDSP block in the LatticeECP2/M family supports four functional elements in three 9, 18 and 36 data path widths. The user selects a function element for a DSP block and then selects the width and type (signed/unsigned) of its operands. The operands in the LatticeECP2/M family sysDSP Blocks can be either signed or unsigned but not mixed within a function element. Similarly, the operand widths cannot be mixed within a block. In the LatticeECP2/M family the DSP elements can be concatenated.

The resources in each sysDSP block can be configured to support the following elements:

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-23 shows the MULT sysDSP element.

Figure 2-23. MULT sysDSP Element

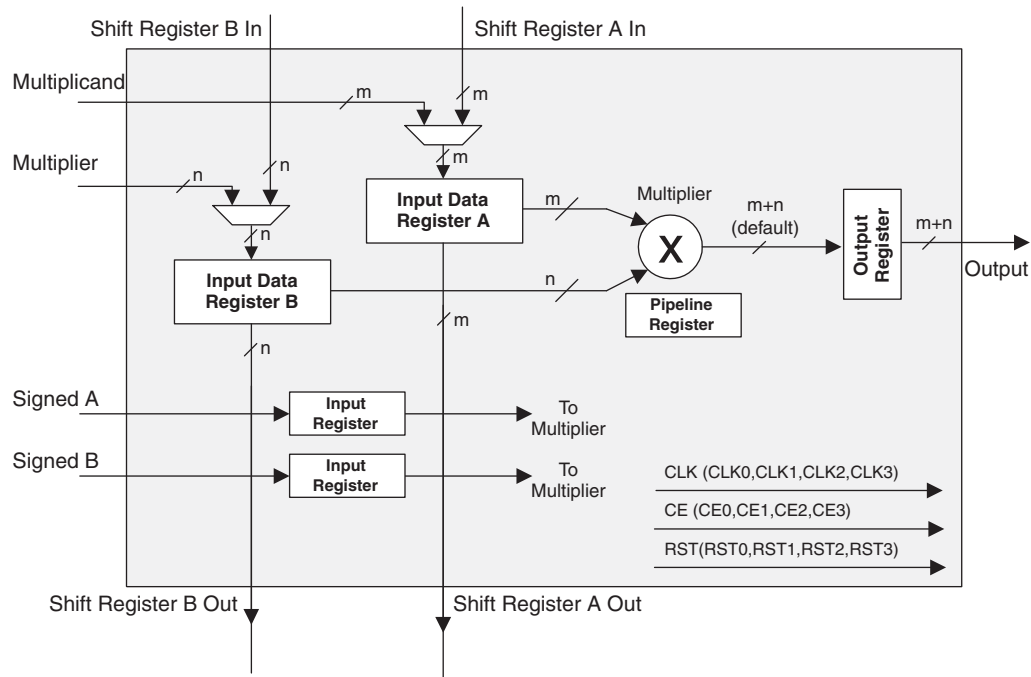
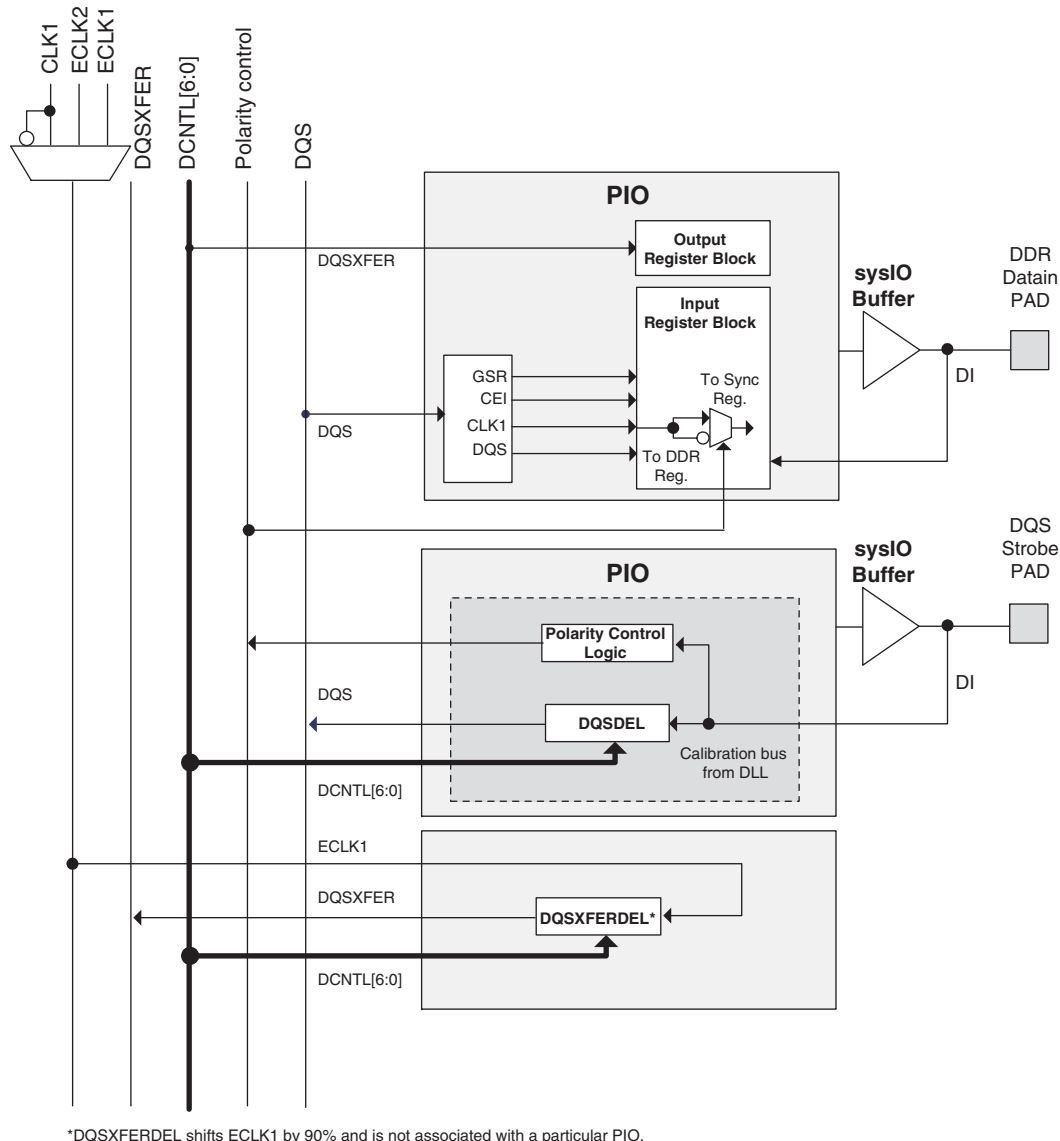


Figure 2-36. DQS Local Bus



*DQSXFERDEL shifts ECLK1 by 90% and is not associated with a particular PIO.

Polarity Control Logic

In a typical DDR Memory interface design, the phase relationship between the incoming delayed DQS strobe and the internal system clock (during the READ cycle) is unknown.

The LatticeECP2/M family contains dedicated circuits to transfer data between these domains. To prevent set-up and hold violations, at the domain transfer between DQS (delayed) and the system clock, a clock polarity selector is used. This changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each READ cycle for the correct clock polarity.

Prior to the READ operation in DDR memories, DQS is in tristate (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit detects the first DQS rising edge after the preamble state. This signal is used to control the polarity of the clock to the synchronizing registers.

sysCLOCK SPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f _{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	33	—	420	MHz
		With external capacitor ^{5, 6}	2	—	420	MHz
f _{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	33	—	420	MHz
		With external capacitor ⁵	5	—	50	MHz
f _{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.258	—	210	MHz
		With external capacitor ⁵	0.039	—	25	MHz
f _{VCO}	PLL VCO Frequency		640	—	1280	MHz
f _{PFD}	Phase Detector Input Frequency	Without external capacitor	33	—	420	MHz
		With external capacitor ⁶	2	—	50	MHz
AC Characteristics						
t _{DT}	Output Clock Duty Cycle	Default Duty Cycle Selected ³	45	50	55	%
t _{PH} ⁴	Output Phase Accuracy		—	—	±0.05	UI
t _{OPJIT} ¹	Output Clock Period Jitter	f _{OUT} ≥ 100 MHz	—	—	±125	ps
		50 ≤ f _{OUT} < 100 MHz	—	—	0.025	UIPP
		f _{OUT} < 50 MHz	—	—	0.04	UIPP
t _{SK}	Input Clock to Output Clock Skew	Divider Ratio = Integer	—	—	±250	ps
t _W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t _{LOCK} ²	PLL Lock-in Time	Without external capacitor	—	—	150	μs
		With external capacitor ⁵	—	—	500	μs
t _{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t _{FBKDLY}	External Feedback Delay		—	—	10	ns
t _{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t _{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t _{RST}	RST Pulse Width (RSTK)		15	—	—	ns
	Reset Signal Pulse Width (RST)	Without external capacitor	500	—	—	ns
		With external capacitor ⁵	20	—	—	μs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.

2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.

3. Using LVDS output buffers.

4. Phase accuracy of CLKOS compared to CLKOP.

5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.

6. $f_{OUT}(\max) = f_{IN} * 10$ for $f_{IN} < 5$ MHz.

LatticeECP2M Power Supply and NC

Signal	256 fpBGA	484 fpBGA
V _{CC}	G7, G9, H7, J10, K10, K8	J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13
V _{CCIO0}	E7	B5, B9, E7, H9
V _{CCIO1}	E10	D13, E16, H14
V _{CCIO2}	E14, G12	E21, G18, J15, K19
V _{CCIO3}	K12, M14	N19, P15, T18, V21
V _{CCIO4}	M10, P12	AA18, R14, V16, W13
V _{CCIO5}	M7, P5	AA5, R9, V7, W10
V _{CCIO6}	K5, M3	N4, P8, T5, V2
V _{CCIO7}	E3, G5	E2, G5, J8, K4
V _{CCIO8}	T15	AA22, U19
V _{CCJ}	K7	W4
V _{CCAUX}	G8, H10, J7, K9	H11, H12, L15, L8, M15, M8, R11, R12
V _{CCPLL}	G10	R8, H15, H8, R15
SERDES Power ³	C15, B15, C12, A12, C11, C10, C14, C13, B9, C9, C5, C4, C8, C7, A6, C6, B3, C3	C22, B22, C19, A19, C18, C17, C21, C20, B16, C16, C12, C11, C15, C14, A13, C13, B10, C10
GND ¹	A1, A15, A16, A3, A9, B12, B6, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16	A1, A10, A16, A22, AA19, AA4, AB1, AB22, B13, B19, B4, D16, D2, D21, D7, G19, G4, H10, H13, J14, J9, K10, K11, K12, K13, K15, K20, K3, K8, L10, L11, L12, L13, M10, M11, M12, M13, N10, N11, N12, N13, N15, N20, N3, N8, P14, P9, R10, R13, T19, T4, W16, W2, W21, W7, Y10, Y13
NC ²	D10, D11, D12, D13, D14, D4, D5, D6, D7, E11, E6, E8, E9, F10, F7, F8, F9	LFE2M20: D14, D15, E14, E15, F13, F14, F15, G12, G13, G14, G15 LFE2M35: D14, D15, E14, E15, F13, F14, F15, G12, G13, G14, G15, U6 LFE2M50: Y15, W15, AB20, AB21, AA20, AB19, AB18, Y22, Y21, Y17, Y18, Y16, W17, Y19, Y20, W19, W18, V17, V18, D15, G14, G15, D14, E15, E14, F15, F14, F13, G12, G13

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. For package migration across device densities, the designer must comprehend the package pin requirements for the SERDES blocks. Specifically, the SERDES power pins of the largest density device must be accounted to accommodate migration to other smaller devices using the same package. Please refer to TN1160, [LatticeECP2/M Density Migration](#) for more details.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
46	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*	
47	PL30A	6	LDQ28		PL44A	6	LDQ42		
48	TCK	-			TCK	-			
49	TDI	-			TDI	-			
50	TDO	-			TDO	-			
51	VCCJ	-			VCCJ	-			
52	TMS	-			TMS	-			
53	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
54	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
55	VCCIO5	5			VCCIO5	5			
56	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
57	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
58	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
59	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
60	GND	-			GND	-			
61	PB12A	5	BDQ15	T	PB12A	5	BDQ15	T	
62	PB12B	5	BDQ15	C	PB12B	5	BDQ15	C	
63	VCCIO5	5			VCCIO5	5			
64	PB16A	5	BDQ15	T	PB16A	5	BDQ15	T	
65	PB16B	5	BDQ15	C	PB16B	5	BDQ15	C	
66	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T	
67	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C	
68	GND	-			GND	-			
69	PB20A	5	BDQ24	T	PB30A	5	BDQ33	T	
70	VCCAUX	-			VCCAUX	-			
71	PB20B	5	BDQ24	C	PB30B	5	BDQ33	C	
72	PB22A	5	BDQ24	T	PB32A	5	BDQ33	T	
73	PB22B	5	BDQ24	C	PB32B	5	BDQ33	C	
74	VCC	-			VCC	-			
75	PB26A	5	PCLKT5_0/BDQ24	T	PB35A	5	PCLKT5_0/BDQ33	T	
76	PB26B	5	PCLKC5_0/BDQ24	C	PB35B	5	PCLKC5_0/BDQ33	C	
77	GND	-			GND	-			
78	PB31A	4	PCLKT4_0/BDQ33	T	PB40A	4	PCLKT4_0/BDQ42	T	
79	PB31B	4	PCLKC4_0/BDQ33	C	PB40B	4	PCLKC4_0/BDQ42	C	
80	VCC	-			VCC	-			
81	GND	-			GND	-			
82	PB34A	4	BDQ33	T	PB42A	4	BDQS42	T	
83	PB34B	4	BDQ33	C	PB42B	4	BDQ42	C	
84	PB36A	4	BDQ33	T	PB44A	4	BDQ42	T	
85	PB36B	4	BDQ33	C	PB44B	4	BDQ42	C	
86	VCCAUX	-			VCCAUX	-			
87	PB40A	4	BDQ42	T	PB50A	4	BDQ51	T	
88	PB40B	4	BDQ42	C	PB50B	4	BDQ51	C	
89	GND	-			GND	-			
90	PB42A	4	BDQS42	T	PB52A	4	BDQ51	T	
91	PB42B	4	BDQ42	C	PB52B	4	BDQ51	C	

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	L11	PB61B	4	BDQ60	C
T13	T13	PB62A	4	BDQ60	T
R13	R13	PB63A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
T14	T14	PB62B	4	BDQ60	C
P13	P13	PB63B	4	BDQ60	C
GND	GND	GNDIO4	-		
N12	N12	PB64A	4	VREF2_4/BDQ60	T
M12	M12	PB64B	4	VREF1_4/BDQ60	C
R15	R15	CFG2	8		
N14	N14	CFG1	8		
N13	N13	PROGRAMN	8		
N15	N15	CFG0	8		
P15	P15	PR44B	8	WRITEN	C
L12	L12	INITN	8		
N16	N16	PR43B	8	CSN	C
GND	GND	GNDIO8	-		
R14	R14	CCLK	8		
P14	P14	PR44A	8	CS1N	T
M13	M13	DONE	8		
R16	R16	PR42B	8	D1	C
VCCIO	VCCIO	VCCIO8	8		
M16	M16	PR43A	8	D0/SPIFASTN	T
P16	P16	PR42A	8	D2	T
L15	L15	PR41B	8	D3	C
GND	GND	GNDIO8	-		
L14	L14	PR40A	8	D6	T
L16	L16	PR41A	8	D4	T
L10	L10	PR39B	8	D7/SPID0	C
L13	L13	PR40B	8	D5	C
VCCIO	VCCIO	VCCIO8	8		
K11	K11	PR39A	8	DI/CSSPI0N	T
K14	K14	PR38B	8	DOU/CSON	C
K13	K13	PR38A	8	BUSY/SISPI	T
GND	GND	GNDIO8	-		
K15	K15	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C
VCCIO	VCCIO	VCCIO3	3		
K16	K16	PR31A	3	RLM0_GPLL_T_FB_A/RDQ34	T
GND	GND	GNDIO3	-		
J16	J16	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*
J15	J15	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*
J14	J14	RLM0_PLLCAP	3		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
A5	A5	PT36B	0		C
A3	A3	PT35B	0		C
A4	A4	PT36A	0		T
VCCIO	VCCIO	VCCIO0	0		
B3	B3	PT35A	0		T
A2	A2	PT34B	0		C
C7	C7	PT33B	0		C
B2	B2	PT34A	0		T
D7	D7	PT33A	0		T
D6	D6	PT32B	0		C
GND	GND	GNDIO0	-		
F7	F7	PT31B	0		C
C6	C6	PT32A	0		T
VCCIO	VCCIO	VCCIO0	0		
F6	F6	PT31A	0		T
C4	C4	PT30B	0		C
B4	B4	PT30A	0		T
-	GND	GNDIO0	0		
-	VCC	VCCIO	0		
D5	D5	PT2B	0	VREF2_0	C
E5	E5	PT2A	0	VREF1_0	T
G7	G7	VCC	-		
G9	G9	VCC	-		
H7	H7	VCC	-		
J10	J10	VCC	-		
K10	K10	VCC	-		
K8	K8	VCC	-		
G8	G8	VCCAUX	-		
H10	H10	VCCAUX	-		
J7	J7	VCCAUX	-		
K9	K9	VCCAUX	-		
C5	C5	VCCIO0	0		
E7	E7	VCCIO0	0		
C12	C12	VCCIO1	1		
E10	E10	VCCIO1	1		
E14	E14	VCCIO2	2		
G12	G12	VCCIO2	2		
K12	K12	VCCIO3	3		
M14	M14	VCCIO3	3		
M10	M10	VCCIO4	4		
P12	P12	VCCIO4	4		
M7	M7	VCCIO5	5		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C20	PT75B	1		C	PT93B	1		C
D20	PT75A	1		T	PT93A	1		T
A22	PT74B	1		C	PT92B	1		C
A21	PT74A	1		T	PT92A	1		T
GND	GNDIO1	-			GNDIO1	-		
E19	PT71B	1		C	PT85B	1		C
C19	PT71A	1		T	PT85A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B21	PT70B	1		C	PT79B	1		C
B20	PT70A	1		T	PT79A	1		T
D19	PT69B	1		C	PT78B	1		C
B19	PT69A	1		T	PT78A	1		T
GND	GNDIO1	-			GNDIO1	-		
G17	PT68B	1		C	PT77B	1		C
E18	PT68A	1		T	PT77A	1		T
G19	PT67B	1		C	PT76B	1		C
F17	PT67A	1		T	PT76A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A20	PT66B	1		C	PT75B	1		C
A19	PT66A	1		T	PT75A	1		T
E17	PT65B	1		C	PT74B	1		C
D18	PT65A	1		T	PT74A	1		T
B18	PT64B	1		C	PT73B	1		C
GND	GNDIO1	-			GNDIO1	-		
A18	PT64A	1		T	PT73A	1		T
E16	PT63B	1		C	PT72B	1		C
G16	PT63A	1		T	PT72A	1		T
F16	PT62B	1		C	PT71B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
H18	PT62A	1		T	PT71A	1		T
A17	PT61B	1		C	PT70B	1		C
B17	PT61A	1		T	PT70A	1		T
C18	PT60B	1		C	PT69B	1		C
B16	PT60A	1		T	PT69A	1		T
C17	PT59B	1		C	PT68B	1		C
GND	GNDIO1	-			GNDIO1	-		
D17	PT59A	1		T	PT68A	1		T
E15	PT58B	1		C	PT67B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
G15	PT58A	1		T	PT67A	1		T
A16	PT57B	1		C	PT66B	1		C
B15	PT57A	1		T	PT66A	1		T
D15	PT56B	1		C	PT65B	1		C
F15	PT56A	1		T	PT65A	1		T
A14	PT55B	1		C	PT64B	1		C
B14	PT55A	1		T	PT64A	1		T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D25	PT99A	1		T
J22	PT98B	1		C
J21	PT98A	1		T
VCCIO	VCCIO1	1		
B25	PT97B	1		C
A25	PT97A	1		T
E24	PT96B	1		C
F24	PT96A	1		T
GND	GNDIO1	-		
F23	PT95B	1		C
H22	PT95A	1		T
D24	PT94B	1		C
C24	PT94A	1		T
VCCIO	VCCIO1	1		
E23	PT93B	1		C
G23	PT93A	1		T
B24	PT92B	1		C
A24	PT92A	1		T
C27	PT91B	1		C
GND	GNDIO1	-		
D27	PT91A	1		T
C26	PT90B	1		C
D26	PT90A	1		T
A27	PT89B	1		C
VCCIO	VCCIO1	1		
B27	PT89A	1		T
A28	PT88B	1		C
B28	PT88A	1		T
A29	PT87B	1		C
B29	PT87A	1		T
GND	GNDIO1	-		
VCCIO	VCCIO1	1		
H21	PT80B	1		C
F22	PT80A	1		T
VCCIO	VCCIO1	1		
B23	PT79B	1		C
A23	PT79A	1		T
G24	PT78B	1		C
E22	PT78A	1		T
GND	GNDIO1	-		
D22	PT77B	1		C
C22	PT77A	1		T
G22	PT76B	1		C

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GNDIO	GNDIO4	-			GNDIO4	-			
AA15	PB42B	4	BDQ42	C	PB60B	4	BDQ60	C	
V15	PB43A	4	BDQ42	T	PB61A	4	BDQ60	T	
U15	PB43B	4	BDQ42	C	PB61B	4	BDQ60	C	
AB16	PB44A	4	BDQ42	T	PB62A	4	BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AA16	PB44B	4	BDQ42	C	PB62B	4	BDQ60	C	
AB17	PB45A	4	BDQ42	T	PB63A	4	BDQ60	T	
AA17	PB45B	4	BDQ42	C	PB63B	4	BDQ60	C	
Y15	PB46A	4	BDQ42	T	PB64A	4	BDQ60	T	
GNDIO	GNDIO4	-			GNDIO4	-			
W15	PB46B	4	BDQ42	C	PB64B	4	BDQ60	C	
AB20	PB47A	4	BDQ51	T	PB65A	4	BDQ69	T	
AB21	PB47B	4	BDQ51	C	PB65B	4	BDQ69	C	
AA21	PB48A	4	BDQ51	T	PB66A	4	BDQ69	T	
AA20	PB48B	4	BDQ51	C	PB66B	4	BDQ69	C	
AB19	PB49A	4	BDQ51	T	PB67A	4	BDQ69	T	
AB18	PB49B	4	BDQ51	C	PB67B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
Y22	PB50A	4	BDQ51	T	PB68A	4	BDQ69	T	
Y21	PB50B	4	BDQ51	C	PB68B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
Y17	PB51A	4	BDQS51	T	PB69A	4	BDQS69	T	
Y18	PB51B	4	BDQ51	C	PB69B	4	BDQ69	C	
Y16	PB52A	4	BDQ51	T	PB70A	4	BDQ69	T	
W17	PB52B	4	BDQ51	C	PB70B	4	BDQ69	C	
Y19	PB53A	4	BDQ51	T	PB71A	4	BDQ69	T	
Y20	PB53B	4	BDQ51	C	PB71B	4	BDQ69	C	
VCCIO	VCCIO4	4			VCCIO4	4			
W19	PB54A	4	BDQ51	T	PB72A	4	BDQ69	T	
W18	PB54B	4	BDQ51	C	PB72B	4	BDQ69	C	
V17	PB55A	4	BDQ51	T	PB73A	4	BDQ69	T	
V18	PB55B	4	BDQ51	C	PB73B	4	BDQ69	C	
GNDIO	GNDIO4	-			GNDIO4	-			
W20	CFG2	8			CFG2	8			
V20	CFG1	8			CFG1	8			
V19	CFG0	8			CFG0	8			
V22	PROGRAMN	8			PROGRAMN	8			
W22	CCLK	8			CCLK	8			
U18	INITN	8			INITN	8			
U22	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
U20	PR53B	8	WRITEN***	C	PR68B	8	WRITEN***	C	
U21	PR53A	8	CS1N***	T	PR68A	8	CS1N***	T	
U17	PR52B	8	CSN***	C	PR67B	8	CSN***	C	
U16	PR52A	8	D0/SPIFASTN***	T	PR67A	8	D0/SPIFASTN***	T	
VCCIO	VCCIO8	8			VCCIO8	8			
T16	PR51B	8	D1***	C	PR66B	8	D1***	C	

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
W19	NC	-		
W18	NC	-		
V17	NC	-		
V18	NC	-		
D15	NC	-		
G14	NC	-		
G15	NC	-		
D14	NC	-		
E15	NC	-		
E14	NC	-		
F15	NC	-		
F14	NC	-		
F13	NC	-		
G12	NC	-		
G13	NC	-		
H8	VCCPLL	-		
H15	VCCPLL	-		
R8	VCCPLL	-		
R15	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
F11	VCCIO0	0			VCCIO0	0			
J13	VCCIO0	0			VCCIO0	0			
K12	VCCIO0	0			VCCIO0	1			
D18	VCCIO1	1			VCCIO1	1			
F16	VCCIO1	1			VCCIO1	1			
J14	VCCIO1	1			VCCIO1	1			
K15	VCCIO1	1			VCCIO1	1			
G25	VCCIO2	2			VCCIO2	2			
L21	VCCIO2	2			VCCIO2	2			
M17	VCCIO2	2			VCCIO2	2			
M25	VCCIO2	2			VCCIO2	2			
N18	VCCIO2	2			VCCIO2	2			
P18	VCCIO3	3			VCCIO3	3			
R17	VCCIO3	3			VCCIO3	3			
R25	VCCIO3	3			VCCIO3	3			
T21	VCCIO3	3			VCCIO3	3			
Y25	VCCIO3	3			VCCIO3	3			
AA16	VCCIO4	4			VCCIO4	4			
AC18	VCCIO4	4			VCCIO4	4			
U15	VCCIO4	4			VCCIO4	4			
V14	VCCIO4	4			VCCIO4	4			
AA11	VCCIO5	5			VCCIO5	5			
V13	VCCIO5	5			VCCIO5	5			
AE12	VCCIO5	5			VCCIO5	5			
AE7	VCCIO5	5			VCCIO5	5			
U12	VCCIO5	5			VCCIO5	5			
P9	VCCIO6	6			VCCIO6	6			
R10	VCCIO6	6			VCCIO6	6			
R2	VCCIO6	6			VCCIO6	6			
T6	VCCIO6	6			VCCIO6	6			
Y2	VCCIO6	6			VCCIO6	6			
G2	VCCIO7	7			VCCIO7	7			
L6	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M2	VCCIO7	7			VCCIO7	7			
N9	VCCIO7	7			VCCIO7	7			
AC24	VCCIO8	8			VCCIO8	8			
U17	VCCIO8	8			VCCIO8	8			
J11	VCCAUX	-			VCCAUX	-			
J12	VCCAUX	-			VCCAUX	-			
J15	VCCAUX	-			VCCAUX	-			
J16	VCCAUX	-			VCCAUX	-			
L18	VCCAUX	-			VCCAUX	-			
L9	VCCAUX	-			VCCAUX	-			
M18	VCCAUX	-			VCCAUX	-			
M9	VCCAUX	-			VCCAUX	-			
R18	VCCAUX	-			VCCAUX	-			
R9	VCCAUX	-			VCCAUX	-			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L16	GND	-			GND	-			
L17	GND	-			GND	-			
L2	GND	-			GND	-			
L20	GND	-			GND	-			
L25	GND	-			GND	-			
L7	GND	-			GND	-			
M13	GND	-			GND	-			
M14	GND	-			GND	-			
N10	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N14	GND	-			GND	-			
N15	GND	-			GND	-			
N17	GND	-			GND	-			
P10	GND	-			GND	-			
P12	GND	-			GND	-			
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P17	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T2	GND	-			GND	-			
T20	GND	-			GND	-			
T25	GND	-			GND	-			
T7	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U16	GND	-			GND	-			
V22	GND	-			GND	-			
V5	GND	-			GND	-			
Y11	GND	-			GND	-			
Y16	GND	-			GND	-			
AB3	NC	-			NC	-			
AB4	NC	-			NC	-			
AC1	NC	-			NC	-			
AC2	NC	-			NC	-			
B4	NC	-			NC	-			
B5	NC	-			NC	-			
C26	NC	-			NC	-			
D20	NC	-			NC	-			
D21	NC	-			NC	-			
D22	NC	-			NC	-			

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L5	PL23A	7	LDQ27	T (LVDS)*	PL33A	7	LDQ37	T (LVDS)*	
L4	PL23B	7	LDQ27	C (LVDS)*	PL33B	7	LDQ37	C (LVDS)*	
N9	PL24A	7	LDQ27	T	PL34A	7	LDQ37	T	
N7	PL24B	7	LDQ27	C	PL34B	7	LDQ37	C	
K2	PL25A	7	LDQ27	T (LVDS)*	PL35A	7	LDQ37	T (LVDS)*	
K1	PL25B	7	LDQ27	C (LVDS)*	PL35B	7	LDQ37	C (LVDS)*	
P9	PL26A	7	LDQ27	T	PL36A	7	LDQ37	T	
P7	PL26B	7	LDQ27	C	PL36B	7	LDQ37	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M6	PL27A	7	LDQS27	T (LVDS)*	PL37A	7	LDQS37	T (LVDS)*	
M5	PL27B	7	LDQ27	C (LVDS)*	PL37B	7	LDQ37	C (LVDS)*	
N5	PL28A	7	LDQ27	T	PL38A	7	LDQ37	T	
N6	PL28B	7	LDQ27	C	PL38B	7	LDQ37	C	
M4	PL29A	7	LDQ27	T (LVDS)*	PL39A	7	LDQ37	T (LVDS)*	
M3	PL29B	7	LDQ27	C (LVDS)*	PL39B	7	LDQ37	C (LVDS)*	
P6	PL30A	7	LDQ27	T	PL40A	7	LDQ37	T	
GNDIO	GNDIO7	-			GNDIO7	-			
P8	PL30B	7	LDQ27	C	PL40B	7	LDQ37	C	
L3	PL32A	7	LUM3_SPLLT_IN_A/LDQ36	T (LVDS)*	PL42A	7	LUM3_SPLLT_IN_A/LDQ46	T (LVDS)*	
L2	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C (LVDS)*	PL42B	7	LUM3_SPLLC_IN_A/LDQ46	C (LVDS)*	
P5	PL33A	7	LUM3_SPLLT_FB_A/LDQ36	T	PL43A	7	LUM3_SPLLT_FB_A/LDQ46	T	
P4	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C	
L1	PL34A	7	LDQ36	T (LVDS)*	PL44A	7	LDQ46	T (LVDS)*	
M2	PL34B	7	LDQ36	C (LVDS)*	PL44B	7	LDQ46	C (LVDS)*	
R5	PL35A	7	LDQ36	T	PL45A	7	LDQ46	T	
R4	PL35B	7	LDQ36	C	PL45B	7	LDQ46	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M1	PL36A	7	LDQS36	T (LVDS)*	PL46A	7	LDQS46	T (LVDS)*	
N2	PL36B	7	LDQ36	C (LVDS)*	PL46B	7	LDQ46	C (LVDS)*	
R8	PL37A	7	LDQ36	T	PL47A	7	LDQ46	T	
T9	PL37B	7	LDQ36	C	PL47B	7	LDQ46	C	
P3	PL38A	7	LDQ36	T (LVDS)*	PL48A	7	LDQ46	T (LVDS)*	
P2	PL38B	7	LDQ36	C (LVDS)*	PL48B	7	LDQ46	C (LVDS)*	
N1	PL39A	7	PCLKT7_0/LDQ36	T	PL49A	7	PCLKT7_0/LDQ46	T	
GNDIO	GNDIO7	-			GNDIO7	-			
P1	PL39B	7	PCLKC7_0/LDQ36	C	PL49B	7	PCLKC7_0/LDQ46	C	
T5	PL41A	6	PCLKT6_0	T (LVDS)*	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*	
T4	PL41B	6	PCLKC6_0	C (LVDS)*	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*	
U7	PL42A	6	VREF2_6	T	PL52A	6	VREF2_6/LDQ55	T	
T8	PL42B	6	VREF1_6	C	PL52B	6	VREF1_6/LDQ55	C	
R3	PL43A	6		T (LVDS)*	PL53A	6	LDQ55	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
R2	PL43B	6		C (LVDS)*	PL53B	6	LDQ55	C (LVDS)*	
R1	PL44A	6		T	PL54A	6	LDQ55	T	
T1	PL44B	6		C	PL54B	6	LDQ55	C	
GNDIO	GNDIO6	-			GNDIO6	-			
-	-	-			VCCIO6	6			
T3	PL45A	6	LLM3_SPLLT_IN_A	T (LVDS)*	PL57A	6	LLM3_SPLLT_IN_A/LDQ55	T (LVDS)*	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P16	GND	-			GND	-			
P17	GND	-			GND	-			
P18	GND	-			GND	-			
P20	GND	-			GND	-			
R10	GND	-			GND	-			
R11	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
R15	GND	-			GND	-			
R16	GND	-			GND	-			
R17	GND	-			GND	-			
R18	GND	-			GND	-			
R20	GND	-			GND	-			
R21	GND	-			GND	-			
R24	GND	-			GND	-			
R7	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T13	GND	-			GND	-			
T14	GND	-			GND	-			
T15	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T18	GND	-			GND	-			
T20	GND	-			GND	-			
T21	GND	-			GND	-			
T24	GND	-			GND	-			
T7	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U15	GND	-			GND	-			
U16	GND	-			GND	-			
U17	GND	-			GND	-			
U18	GND	-			GND	-			
U20	GND	-			GND	-			
V14	GND	-			GND	-			
V15	GND	-			GND	-			
V16	GND	-			GND	-			
V17	GND	-			GND	-			
V27	GND	-			GND	-			
V4	GND	-			GND	-			
W23	GND	-			GND	-			
W8	GND	-			GND	-			
Y14	GND	-			GND	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M23	GND	-		
M8	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N27	GND	-		
N4	GND	-		
P11	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P20	GND	-		
R10	GND	-		
R11	GND	-		
R13	GND	-		
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R20	GND	-		
R21	GND	-		
R24	GND	-		
R7	GND	-		
T10	GND	-		
T11	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T20	GND	-		
T21	GND	-		
T24	GND	-		
T7	GND	-		
U11	GND	-		
U13	GND	-		
U14	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
E4	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F25	NC	-			NC	-		
F26	NC	-			NC	-		
F27	NC	-			NC	-		
F28	NC	-			NC	-		
F29	NC	-			NC	-		
F30	NC	-			NC	-		
F31	NC	-			NC	-		
F32	NC	-			NC	-		
F33	NC	-			NC	-		
F34	NC	-			NC	-		
F5	NC	-			NC	-		
F6	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		
G10	NC	-			NC	-		
G11	NC	-			NC	-		
G24	NC	-			NC	-		
G25	NC	-			NC	-		
G26	NC	-			NC	-		
G27	NC	-			NC	-		
G28	NC	-			NC	-		
G29	NC	-			NC	-		
G30	NC	-			NC	-		
G33	NC	-			NC	-		
G34	NC	-			NC	-		
G7	NC	-			NC	-		
G8	NC	-			NC	-		
G9	NC	-			NC	-		
H10	NC	-			NC	-		
H11	NC	-			NC	-		
H24	NC	-			NC	-		
H25	NC	-			NC	-		
H26	NC	-			NC	-		
H27	NC	-			NC	-		
H28	NC	-			NC	-		
H29	NC	-			NC	-		
H8	NC	-			NC	-		
H9	NC	-			NC	-		
J10	NC	-			NC	-		
J11	NC	-			NC	-		
J24	NC	-			NC	-		
J25	NC	-			NC	-		
J26	NC	-			NC	-		
J9	NC	-			NC	-		
K10	NC	-			NC	-		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5FN1152C	520	1.2V	-5	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-6FN1152C	520	1.2V	-6	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-7FN1152C	520	1.2V	-7	Lead-Free fpBGA	1152	Com	100
LFE2M100SE-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	Com	100
LFE2M100SE-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	Com	100
LFE2M100SE-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	Com	100

Date	Version	Section	Change Summary
August 2006 (cont.)	01.1 (cont.)	Pinout Information (cont.)	Added Information on: Available Device Resources per Packaged Device table.
		Ordering Information	Updated ordering part number table to include ECP2-12.
			Updated topside mark drawing.
September 2006	02.0	Multiple	Added information regarding LatticeECP2M support throughout.
September 2006	02.1	DC and Switching Characteristics	Added Receiver Total Jitter Tolerance Specification table.
			Removed power-up requirements for proper configuration footnote in Recommended Operating Conditions table.
December 2006	02.2	Introduction	LatticeECP2M Selection Guide table has been updated.
		Architecture	Figure 2-16. Per Region Secondary Clock Selection has been updated.
			Figure 2-39. Simplified Channel Block Diagram for SERDES and PCS has been updated.
		DC and Switching	Footnotes have been added to Recommended Operating Conditions.
			DC Electrical Characteristics table has been updated.
			Supply Current (Standby) tables have been updated.
			Initialization Supply Current table have been updated.
			Updated timing numbers to include LFE2-12E (rev A 0.08).
		Pinout Information	Updated to include the entire ECP2 device information as well as 256-fpBGA and 484-fpBGA pin information for the ECP2M35E.
		Ordering Information	Updated to include the entire ECP2 and ECP2M device ordering information.
February 2007	02.3	Architecture	Updated EBR Asynchronous Reset section.
March 2007	02.4	DC and Switching Characteristics	Power-sequencing footnotes have been added to the Recommended Operating Conditions. DDR2 performance has been updated to 266MHz.
March 2007	02.5	Introduction	Added "Security Series" to the LatticeECP2 and LatticeECP2M families.
		Architecture	Enhanced Configuration Option section updated.
		DC and Switching	Recommended Operating Conditions table - footnote 4 updated.
		Ordering Information	"Security Series" ordering part numbers added.
April 2007	02.6	Introduction	LatticeECP2M family table has been updated for user I/O counts.
		Ordering Information	LatticeECP2M family ordering part number section has been updated to add 1152-fpBGA package for the ECP2M70 and ECP2M100.
July 2007	02.7	Architecture	Updated text in Ripple Mode section.
		DC and Switching	ECP2/M Supply Current information has been updated. Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLN Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.10). SERDES timing information has been updated. PCI Express timing information has been updated.
		Pinout Information	Added LatticeECP2M20 pinout information.
August 2007	02.8	Introduction	1156-fpBGA package option has been removed from the LatticeECP2M family.
		Architecture	Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration table has been updated.
		DC and Switching	Supply Current (Standby) table has been updated.
			DSP Function timing has been updated.